swissbit[®]

EMBEDDED MEMORY & STORAGE SOLUTIONS



AUTOMOTIVE • COMMUNICATIONS INDUSTRIAL • NETWORKING • SECURITY

WHAT SEPERATES US FROM THE OTHERS

Data is the fuel of the future and is driving global growth and change. As a leader in industrial data storage, Swissbit recognizes the undeniable need for reliable and secure storage solutions as an integral part of the digital transformation age.

More than 5000 customers around the world including Fortune 500 companies and the world's leading 0EM's already rely on Swissbit for their safety-critical data-storage requirements. With over 25 years of experience in the development of removable & embedded memory solutions for the most demanding markets coupled with a trusted global distribution & support network, Swissbit is firmly established as a global innovation leader in storage technology for high-reliability solutions.

Swissbit's state-of-the-art centralized and wholly owned manufacturing, testing and packing facility in Berlin ensures supply chain integrity that delivers fail-safe industrial strength flash memory solutions for safety-critical applications including industrial, medical, automotive and communication networking.

Swissbit's devices and proprietary firmware meet the highest technology & safety requirements so that customers can trust that their data is stored, protected and secured even in harsh environments and under the most difficult conditions. Whether flash memory solutions for extreme temperatures or tamper-proof secure data storage, all Swissbit products meet the highest quality criteria and performance benchmarks. When you need a reliable long-term source for your memory solutions, Swissbit is your partner you can trust to deliver.

CORPORATE PROFILE

Established

1992 – 2000 as SIEMENS AG Swissbit AG was formed in 2001 through a management buyout

Financial Strength

Privately held company, equity ratio > 60%

CAGR 2009-2017

Double digit annual growth

Headquarters

Swissbit Group: Gais, Switzerland Swissbit AG: Bronschhofen (St. Gallen, Lake Constance area)

Subsidiaries

Switzerland, Germany, USA, Japan, Taiwan

R & D sites

Switzerland, Germany and USA

Production Site Berlin, Germany

CONTENT

OUR PRODUCTS







NAND FLASH PRODUCTS

NAND flash products 20 PCIe SSD modules 22 2.5" SATA SSDs 24 SATA modules 26 CFAST™ Cards 30 CompactFlash™ 32 SD Memory Cards 34 microSD Cards 36 Managed NAND 38 **USB** products 40

29

Part Number Decoder

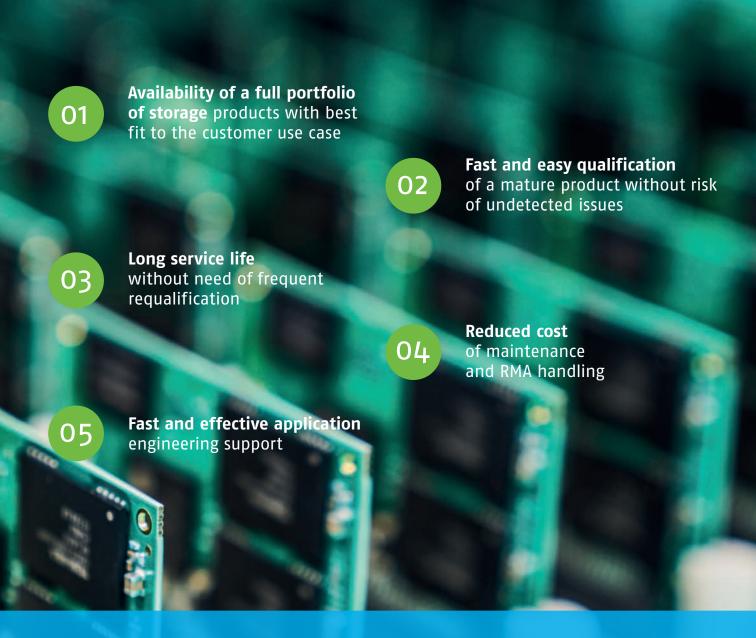
SECURITY PRODUCTS

Security solutions	42
Security editions	44

SIP PRODUCTS

SIP				46





SAFE PROCESSES THROUGH RELIABLE DEVELOPMENT

- Product design and development with focus on embedded, NetCom and automotive market requirements
- Optimized for demanding applications
- Stringent hardware and firmware qualification verify design effort

SAVINGS THROUGH LONG SERVICE LIFE

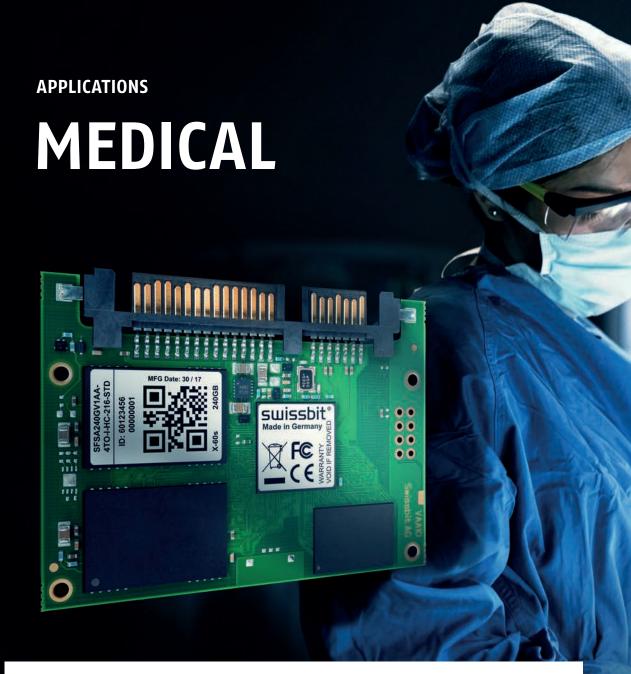
- Swissbit products use components with long-term availability
- The service life of Swissbit products exceed industry practice by far
- Swissbit commits to frozen BOM and PCN process

MAXIMUM STABILITY

- Improved signal integrity
- In-house COB process for maximum mechanical robustness
- PCB design and soldering process withstand high thermal stress
- True industrial temperature support
- Firmware for highest endurance







MEDICAL PRODUCTS

There is a vast array of medical applications, ranging from diagnostic instruments as MRI and CT scanners, ultrasound systems, to blood testing and dialysis machines and infusion pumps. The amount of data stored can be small, as in heart rate monitoring equipment for example, or large as in X-Ray imaging. Nonetheless there is one common aspect: qualifying and certifying components for medical use is a lengthy, expensive task and the timeline from

the initial testing to volume production may extend over several years. Any requalification needs to be avoided as much as possible. This requires storage products that have a frozen BOM and long availability for many years. The portfolio of products for medical use range from SD memory cards or CF cards for handheld medical appliances, to 2.5" or M.2 SSDs with high bandwidth and capacity for medical imaging.



We rely on medical instruments in the most critical conditions of our lives. There is no tolerance for malfunctioning systems. Swissbit understands these requirements and serves the medical industry with storage products that fulfill the highest quality standards. Additionally, Swissbit's secure storage products protect the patients' medical data against unauthorized access. For more details on security products see page 42.

TYPICAL APPLICATIONS:

- Diagnostics
- Medical imaging
- Medical treatment
- Point-of-care testing
- Monitoring systems
- Augmented reality
- Medical vision



NETWORKING & COMMUNICATION



NETCOM PRODUCTS

Swissbit supports the demanding field of NetCom applications with products that withstand a wide range of frequent temperature changes and operate between -40°C and +85°C. It is mandatory that products perform for an extended life time in the field without the need for replacement or service. Swissbit's durabit™ range of SSDs fulfil this requirement.

For system boot purposes, a common frequently utilized device is the embedded USB module. With the U-4x and U-5x family, Swissbit offers a broad range of capacities and interface modes. Data care management with retention optimization maintains the boot image data over the complete service life and guarantees a safe and fast restart of the NetCom system.

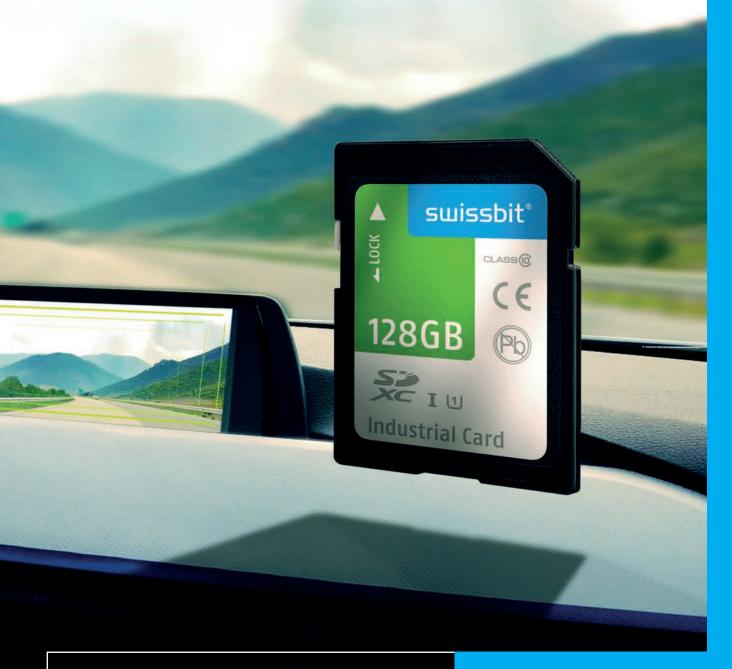
The latest technologies and life changing developments rely on the Internet. The Internet of Things (IoT), the Industrial Internet of Things (IIoT) or Industry 4.0 (IND4.0) cannot be realized without a strong network of communication channels. Transmitting data to remote areas of the world is quite challenging and involves a high cost. Transceivers, routers and bridges which require uninterrupted, autonomous 24/7 operation, are often under extreme environmental conditions and may be installed in difficult to service areas.

TYPICAL APPLICATIONS:

- ATCA Blade
- Cable modem
- Content and video delivery
- Digital Subscriber Line access multiplexer
- Enterprise Media Gateway
- Switches and routers
- Optical network
- Radar / Sonar
- Radio network controller
- Security
- Tetra Base Station
- Wireless Base Station





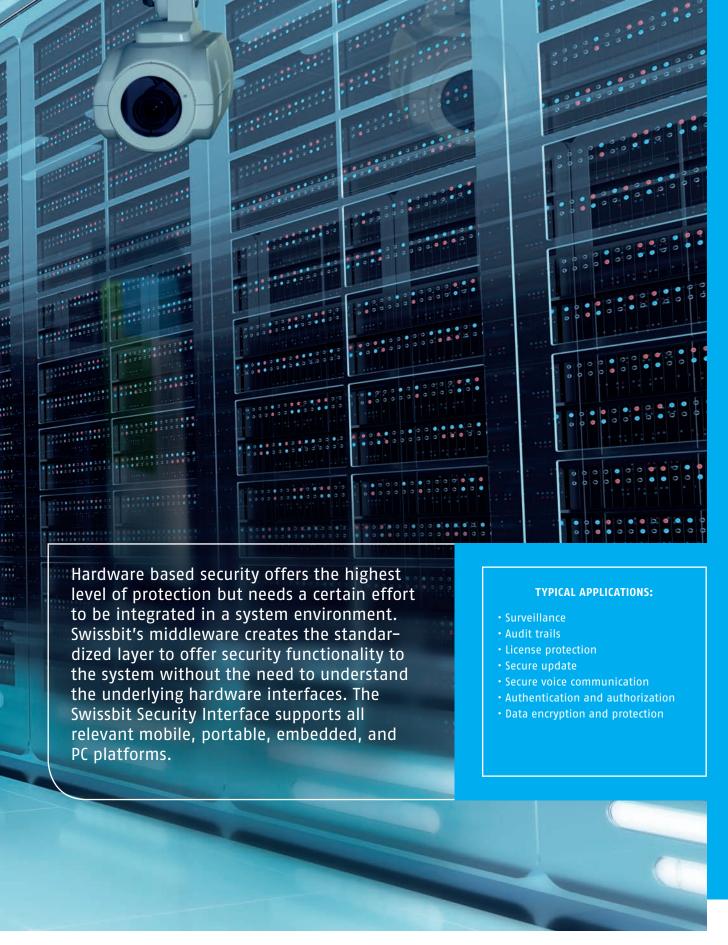


The increasing varieties of infotainment and dashboard applications in cars today require significantly higher storage capacities than before. For autonomous driving the demand for fast and high capacity storage drives the development of embedded products. Swissbit participates in this trend with newly developed dedicated storage solutions.

TYPICAL APPLICATIONS:

- Entertainment systems
- Navigation systems
- · Head unit / dashboard
- Black box / crash recorder
- Instrument cluster
- Dash cam





PRODUCT FEATURES

ROBUSTNESS FEATURES



SHOCK AND VIBRATION

The design, assembly, and use of selected materials guarantee extreme mechanical robustness.



CONFORMAL COATING

A thin polyurethane film protects against aggressive environmental conditions such as dust, moisture, or corrosive gas.



LONGEVITY

These products offer the lowest TCO in demanding applications with high requalification cost.

PERFORMANCE FEATURES



HIGH PERFORMANCE

Optimized for high sequential data rates and IOPS by use of SLC technology.



WAF REDUCTION

The WAF (write amplification factor) for MLC based products is reduced by combining a paged based FW block management with a powerful card architecture and configuration settings.

DATA FEATURES



DATA CARE MANAGEMENT

Multiple routines inside the controller firmware improve data quality and eliminate degradation effects.



LIFE TIME MONITORING (LTM)

The Swissbit Life Time Monitoring feature enables users to access the memory device's detailed Life Time Status and allows remaining lifetime prediction thereby avoiding unexpected data loss.



SECURE ERASE (SANITIZE / PURGE) / FAST ERASE

This feature uses an uninterruptable sequence of data erase commands.



READ-ONLY OPTIMIZED

For such cases content is written to the NAND flash once, the firmware can be optimized to guarantee the highest possible data retention and read disturb.



TRIM SUPPORT

Expired data can be released and deleted in the Flash which reduces garbage collection and increases life time.



ZONE PROTECTION

The device allows the configuration of multiple zones with either no protection, write protection, or access protected settings.

TEMPERATURE FEATURES



WIDE TEMPERATURE SUPPORT

The products are designed and approved for reliable operation over a wide temperature range.



TEMPERATURE SENSOR

The sensor allows the host hardware or software to monitor the storage device temperature.

ELECTRONIC FEATURES



ESD AND EMI SAFE

The product designs are in line with the latest regulations for electrostatic discharge and electromagnetic interference.



LOW POWER CONSUMPTION

Electronic devices with lower power consumption decrease energy cost, prolong battery life, and reduce heat generation in the device and hence require less cooling.



WEAR LEVELING

Sophisticated wear leveling and bad block management ensure that flash cells are sparingly and equally used to prolong the device's life.



IN FIELD FW UPDATE

The storage product can be upgraded with new FW in the field. The upgrade process is protected against power loss.



POWER FAIL PROTECTION & RECOVERY

During an unintentional shutdown, firmware routines and intelligent hard-ware architecture ensure that no corruption of user or system data will occur.

SECURITY FEATURES



TRUE HARDWARE RNG

True random numbers are generated inside the secure element to prevent brute force attacks.



DIGITAL SIGNATURE & VERFICATION

Digital signatures are very popular and inevitable to protect against data or code manipulation.



HARDWARE BASED DATA ENCRYPTION

Hardware based security is key when it comes to replaceability, simple workflows, and trusted runtime environments.



MOBILE BANKING & EPURSE

Strong authentication and offline security for mobile banking and payment.



DEVICE PROTECTION BY DUAL FACTOR AUTHENTICATION

AUTHENTICATION

The user needs to have the card and know the PIN.



SECURE VOICE

The product is optimal for fast, encrypted, and user friendly secure voice solutions.



ELLIPTIC CURVE CRYPTOGRAPHY SUPPORT

Elliptic curves are faster and more efficient than RSA cryptography.



DATA PROTECTION & ENCRYPTION

The card offers a data safe function with strong AES encryption and PIN access protection.



SECURE LOGGING

Any data can be stored securely in write-once mode, queue mode, or random-access mode.



SECURE CD-ROM

Important data can be modified only after PIN authentication.



PRESALES

YOUR FUTURE WITH OUR SOLUTION

Our experienced BDM and FAE teams in Europe, North America, and Asia support you in the selection and qualification of the most suitable memory and storage solution for your applications.

This includes TCO analysis with the Swissbit Lifetime Monitor, hardware or firmware customization, middleware development, the provision of evaluation units and ultimately a joint qualification.

SALES

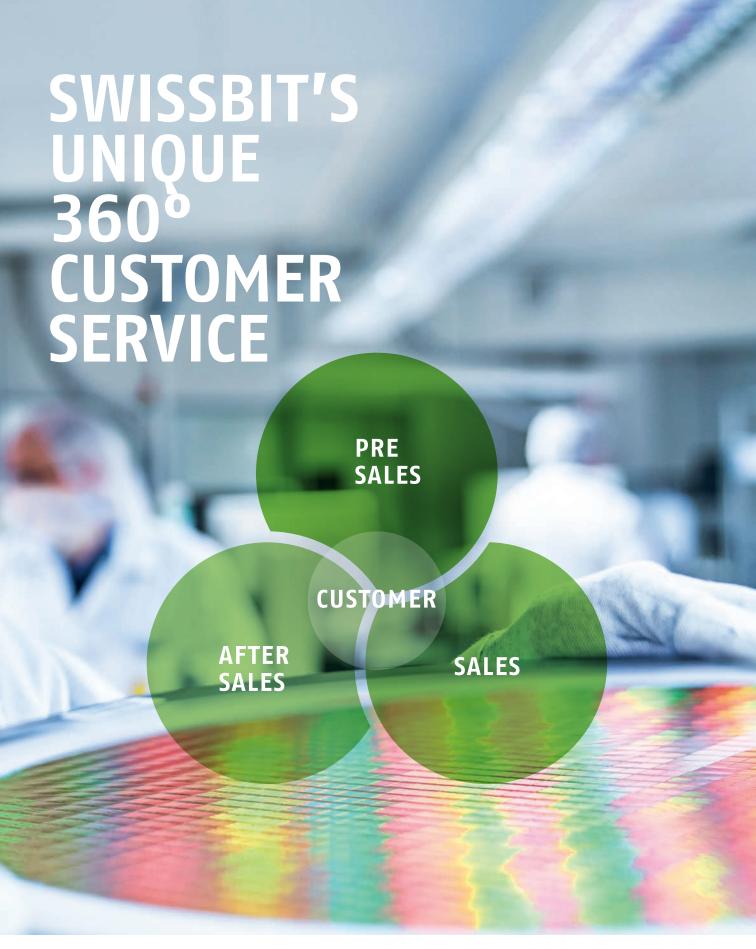
YOUR TRUSTWORTHY PARTNER

We understand the importance of providing local support in your language and time zone. For that reason, Swissbit has established sales offices in all major regions plus a strong network of partners that reaches even farther. Our experienced sales teams manage forecasting and order fulfillment, if desired also through third-party logistics or distribution networks.

AFTERSALES

LOCAL SUPPORT - GLOBALLY

Our engagement stretches far beyond the delivery of our products. Through sophisticated lifecycle management, we can ensure maximum longevity and smooth transitions in the event of product changes. And while we are proud of our best-in-class quality, we are still prepared to provide fast and solution-oriented RMA support at any time, including 4D and 8D reports whenever required.





SWISSBIT'S EMBEDDED STORAGE SOLUTIONS

Our sophisticated flash handling algorithms optimize performance and life of the Single Level Cell (SLC) and Multi Level Cell (MLC) NAND flash used in our products.

OEM's of various industries require a variety of memory and storage solutions. In contrast to typical consumer devices, Swissbit's embedded memory and storage solutions are designed for highest reliability under extreme environmental conditions. They come with a large feature set tailored to the demands of the industrial, automotive, and NetCom markets and with our commitment to longterm availability. Swissbit's embedded

memory and storage solutions portfolio covers all relevant interfaces and form factors including SD and microSD memory cards, CompactFlash™ and CFast™ cards, 2.5" SATA SSDs, SLIM SATA and mSATA SSDs, M.2, USB Flash Drives (UFD) and modules. Our sophisticated flash handling algorithms optimize performance and life of the Single Level Cell (SLC) and Multi Level Cell (MLC) NAND flash used in our products.

			-			
	SLC	everbit™ pSLC	durabit™ The better MLC	MLC	TLC	
Chip Capacity	•	• •	• • •	• • •		
Cost per Bit		• • •	0 0	0 0	0	
Reliability & Endurance	• • • •			0 0	۰	
Industrial Temperature	• • • •	• • •	• • •	0 0 0	•	
Write Performance	• • • •	• • • •		0 0 0	•	
ECC Requirement	•	• •	0 0	0 0		
Data Retention	• • • •	• • •	• • •	0 0 0	٠	
Longevity		• •			۰	

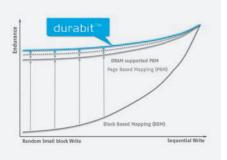


As explained in the box to the right, the endurance and performance of a FLASH product is massively defined by the internal write amplification (WAF). The way in which customer applications write to the storage device has a high impact on the WAF but is difficult to calculate analytically. Swissbit supports a realistic evaluation of the WAF and the endurance of their SSDs and storage cards with help of the Swissbit Life Time Monitoring Tool and statistical data stored into the flash by the firmware. This tool can read out the real usage

data such as number of writes and erase cycles, the bad block statistic, the successful ECC correction, and provides all the data necessary to extrapolate the lifetime of the device.

Swissbit durabit™ products use architectural improvements such as page based FTL, increased overprovisioning and DRAM supported flash management to significantly decrease the WAF for small writes. This enables unprecedented endurance and write performance in these critical use cases.

SSD ENDURANCE



PCIe SSD Modules

Although SATA is still a dominant interface in embedded and NetCom systems, the future belongs to PCIe. PCIe breaks the bandwidth limitations of SATA and offers flexible solutions with multiple lanes that can be combined.

The second innovation to increase the performance is the new protocol NVMe, which has been designed specifically for Non Volatile Memory. The protocol significantly reduces the latency of read and

write requests. The higher performance also requires higher power consumption, especially with the common 4-lane configuration. The Swissbit N-10m2 module, a PCle Gen3 / NVMe 1.2 module only uses 2 PCle lanes and reduces the power consumption without sacrificing performance. Even if only operated with one PCle lane, the performance still exceeds the SATA limits.



N-10m2



GENERAL INFORMATION

ТҮРЕ	m.2 PCIe / NVMe						
STANDARD & INTERFACE	OCI Express (PCIe) Specification Revision 3.1 / NVMe 1.2						
PACKAGE	PCI Express® M.2 (2280)						
OUTLINE DIMENSIONS	80 x 22 x 3.6 mm						
FLASH TYPE	3D NAND						
DENSITY RANGE	120 GB - 960 GB						
DATA RETENTION	10 years @ life begin 1 year @ life end						
ENDURANCE	3,000 P/E cycles (Flash Cell Level)						

TEMPERATURE

OPERATING TEMPERATURE	Commercial: o°C to +70°C
STORAGE TEMPERATURE	-4o°C to +85°C

PERFORMANCE

SEQUENTIAL READ (MB/S) SEQUENTIAL WRITE (MB/S) RANDOM 4KB READ (10PS) RANDOM 4KB WRITE (10PS)	up to 1,600 up to 1,100 up to 197,000 up to 199,000
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ELECTRICAL DATA

VOLTAGE	2.70-3.60 V
POWER CONSUMPTION	Typ. Read Active: 3.1 W Typ. Write Active: 3.3 W Power State 3: < 50 mW

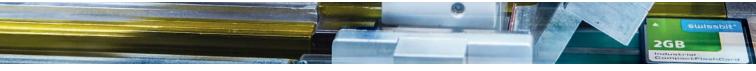
FEATURE LIST

FEATURES & TOOLS	Best-in-Class Performance and Endurance with durabit™ Technology Dynamic and Static Wear Leveling, Dynamic Bad Block Remapping Active and Passive Data Care Management On-Board Power Fail Protection Active State Power Management (ASPM) Support NVMe Security Command Support In-Field Firmware Update Self-Monitoring, Analysis, and Reporting Technology (S.M.A.R.T.) AES256 Encryption (on request) Swissbit Life Time Monitoring (SBLTM) Tool and SDK for SBLTM (on request)
PART NUMBER	SFPCxxxGMxAGxss-C-dd-rrr-ccc



	**	4	7	000	_	4.		#	44		**	3	∞	WAF
X-600	•	•	•	•	•	•	•	•	•	•	•	*	•	•
X-60 / X-66	•	•	•	•	•	•	•	•	•	•	•	*	0	•
X-60P	•	•	•	•	•	•	•	*	•	•	•	*	0	•
X-500	•	•	•	•	•	•	•	•	•	0	•	0	•	0
X-70	•	•	•	•	•	•	•	•	•	•	•	*	0	•

★ Industry Leading; • default implemented; • on request; • not available



X-600 / X-66 / X-60 / X-60P X-500



X-70







GENERAL INFORMATION

ТҮРЕ	2.5" SATA III SSD	2.5" SATA SSD	2.5" SATA IIISSD
INTERFACE DATA TRANSFER MODE	SATA III – 6 Gbit/s ATA8	SATA II - 3 Gbit/s up to P104, MDMA2, UDMA6	SATA III - 6 Gbit/s ATA8
CONNECTOR	15 + 7 pin Serial ATA	15 + 7 pin Serial ATA with latch protection / special feature connector	15 + 7 pin Serial ATA
OUTLINE DIMENSIONS	100.2 x 69.85 x 7.0 mm	100.2 x 69.85 x 9.3 mm	100.2 x 69.85 x 7.0 mm
FLASH TYPE	SLC / pSLC / MLC	SLC	3D NAND
DENSITY RANGE	SLC: X-600: 8 GB - 256 GB pSLC: X-66: 16 GB - 240 GB MLC: X-60: 30 GB - 960 GB	16 GB - 512 GB	240 GB - 2 TB
DATA RETENTION		10 years @ life begin 1 year @ life end	
ENDURANCE ENTERPRISE WL	8.7 / 3.8 / o.6 TBW per GB drive capacity	5.8 TBW per GB drive capacity	tbd/ 3,000 P/E cycles (Flash cell level)

TEMPERATURE

OPERATING TEMPERATURE	Commercial Industrial: -	Commercial: o°C to +70°C		
STORAGE TEMPERATURE	-40°C to +85°C	-55°C to +95°C	-40°C to +85°C	
PERFORMANCE				
BURST RATE (MB/S)	up to 600	up to 300	up to 600	
SEQUENTIAL READ (MB/S)	up to 520 / 520 / 520	up to 240	up to 560	
SEQUENTIAL WRITE (MB/S)	up to 425 / 450 / 450	up to 220	up to 530	
RANDOM 4KB READ (IOPS)	up to 79,000 / 80,000 / 74,000	up to 14,500	up to 81,000	
RANDOM 4KB WRITE (IOPS)	up to 76,000 / 75,000 / 75,000	up to 5,300	up to 81,000	

ROBUSTNESS

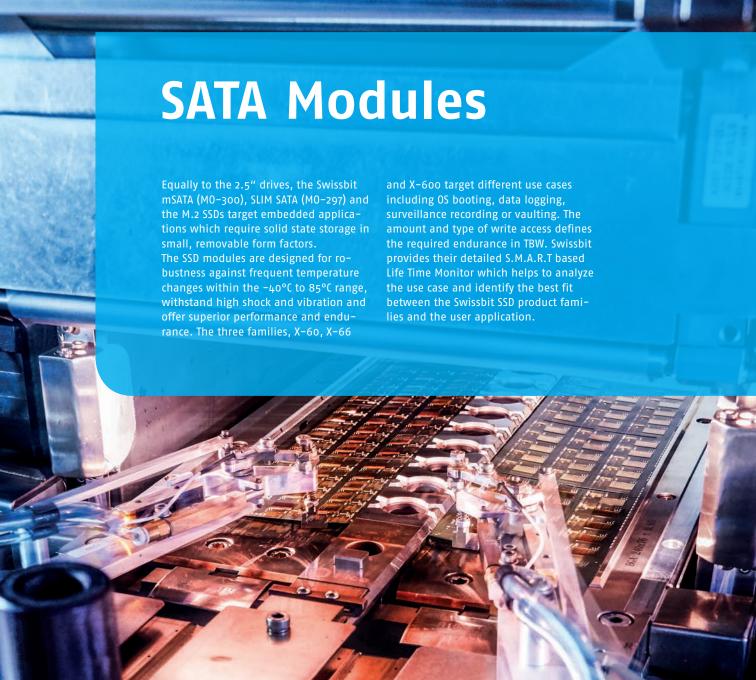
MTBF	≥2,000,000 hours
SHOCK	1,500 G, 0.5 ms
VIBRATION	50 G, 131-2,000 Hz
HUMIDITY	X-60/X-70: 85 % RH 85 °C, 1,000 hrs / X-60P: 65 % RH 85 °C, 1,000 hrs

ELECTRICAL DATA

VOLTAGE	5 V ± 10% / 3.3 V ± 5%	5 V ± 10 % / 3.3 V optional	5 V ± 10 %
POWER CONSUMPTION	typ 300 mA max 1,200 mA Idle 60 mA DEVSLP <5 mA	Slumber 140 mA max 700 mA Idle 200 mA	max 650 mA Idle 100 mA DEVSLP <1 mA

EEATUDE LICT

FEATURE LIST			
FEATURES & TOOLS	X-6oP: with Pfail Circuitry Proven Power Fail Safety NCQ, TRIM Advanced Wear Leveling & Bad Block management In-field firmware update SBLTM Tool & SDK for S.M.A.R.T. based Life Time Monitoring Self encrypted drive (SED) / TCG OPAL optional	Proven Power Fail Safety ATA security feature set Enhanced Secure Erase, Purge & Sanitize features (MIL STD) NCQ, TRIM Advanced Wear Leveling & Bad Block management In-field firmware update SBLTM Tool & SDK for S.M.A.R.T. based Life Time Monitoring	Proven Power Fail Safety NCQ, TRIM Advanced Wear Leveling & Bad Block management In-field firmware update SBLTM Tool & SDK for S.M.A.R.T. based Life Time Monitoring Self encrypted drive (SED) / TCG OPAL optional
PART NUMBER	SFSAxxxxQvAAxss-t-dd-rrr-ccc	SFSAxxxxQvBJxss-t-dd-rrr-ccc	SFSAxxxxQvAHxss-t-dd-rrr-ccc



	**	4	P	000		4.			44			8	∞	WAF
X-600m/s/m2	•	•	•	•	•	•	•	•	•	•	•	*	•	•
X-60 / X-66m/s/m2	•	•	•	•	•	•	•	•	•	•	•	*	0	•
X-200m/s	•	•	•	•	0	•	0	•	•	0	0	0	•	0

★ Industry Leading; • default implemented; • on request; • not available

X-600m X-600s X-600m2 X-200m X-200s











GENERAL INFORMATION

ТҮРЕ	M0-300 mSATA	MO-297 SLIM SATA	M.2 2242	M.2 2260 / 2280	M0-300 mSATA	M0-297 SLIM SATA	
INTERFACE DATA TRANSFER MODE		SATA III - 6 Gbi ATA8		SATA II – 3 Gbit/s up to PIO4, MDMA2, UDMA6			
CONNECTOR	52 pos. Edge Connector PCI Express (PCIe) mini	15 + 7 pin Serial ATA Connector	Con	os. Edge nector M key	52 pos. PCI Express (PCIe) mini	15 + 7 pin Serial ATA Connector	
OUTLINE DIMENSIONS	50.8 x 29.85 mm	54 x 39 mm	22 X 42 mm	22 x 60 / 80 mm	50.8 x 29.85 mm	54 x 39 mm	
THICKNESS	3.3 mm	4.0 mm	3.6 mm	DS: 3.6 mm SS: 2.0 mm	3.3 mm	4.0 mm	
FLASH TYPE			:	SLC			
DENSITY RANGE	8 GB - 128 GB	8 GB - 128 GB 16 GB - 128 GB 8 GB - 64 GB 16 GB - 128 GB			2 GB - 64 GB		
DATA RETENTION	10 years @ life begin 1 year @ life end						
ENDURANCE	max. 8.7 TBW per GB drive capacity (JEDEC Enterprise WL)				100,000 P/E cycles (Flash cell level)		

TEMPERATURE

OPERATING TEMPERATURE	Commercial: o°C to +70°C Industrial: -40°C to +85°C
STORAGE TEMPERATURE	-40°C to +85°C

PERFORMANCE

BURST RATE (MB/S)	up to 600	up to 600	up to 600	up to 300
SEQUENTIAL READ (MB/S)	up to 520	up to 520	up to 520	up to 120
SEQUENTIAL WRITE (MB/S)	up to 405	up to 245	up to 405	up to 95
RANDOM 4KB READ (IOPS)	up to 76,000	up to 76,000	up to 76,000	up to 3,100
RANDOM 4KB WRITE (IOPS)	up to 73,000	up to 54,000	up to 73,000	up to 25

ROBUSTNESS

MTBF	≥2,000,000 hours			
SHOCK	1,500 G, 0.5 ms			
VIBRATION	50 G, 131-2,000 Hz			
HUMIDITY	85 % RH 85°C, 1,000 hrs			

ELECTRICAL DATA

VOLTAGE	3.3 V ± 5 %	5 V ± 10 %	3.3 \	/ ± 5 %	3.3 V ± 5 %	5 V ± 10 %
POWER CONSUMPTION	typ 450 mA max 750 mA Idle 115 mA DEVSLP 35 mA	typ 450 mA max 750 mA Idle 110 mA DEVSLP 55 mA	typ 450 mA max 520 mA Idle 115 mA DEVSLP 35 mA	typ 450 mA max 750 mA Idle 115 mA DEVSLP 35 mA	typ 300 mA max 490 mA Idle 180 mA	typ 260 mA max 320 mA Idle 140 mA

FEATURE LIST

FEATURES & TOOLS	Proven Power Fail Safety NCQ, TRIM FEATURES & TOOLS Advanced Wear Leveling & Bad Block management In-field firmware update				Proven Power Fail Safety Advanced Wear Leveling & Bad Block management SBLTM Tool & SDK for S.M.A.R.T. based Life			
	SBLTM Tool	& SDK for S.M.A.R.T. base	Time N	1onitoring				
PART NUMBER	SFSAxxxxUvAAxss- tdd-rrr-ccc	SFSAxxxxVvAAxss- tdd-rrr-ccc	SFSAxxxxMvAAxss-tdd- rrr-ccc	SFSAxxxxUvBRxss- tdd-rrr-ccc	SFSAxxxxVvBRxss- tdd-rrr-ccc			

X-60m / X-66m X-60s / X-66s X-60m2 / X-66m2









GENERAL INFORMATION

ТҮРЕ	X-60m / X-66m	X-60s / X-66s	X-60m2 / X-66m2			
INTERFACE DATA TRANSFER MODE	SATA III – 6 Gbit/s ATA8					
CONNECTOR	52 pos. Edge Connector PCI Express (PCIe) mini	15 + 7 pin Serial ATA Connector	75 pos. Edge Connector B & M key			
OUTLINE DIMENSIONS	50.8 x 29.85 mm	54 x 39 mm	22 X 42 mm	22 x 60 / 80 mm		
THICKNESS	3.3 mm	4.0 mm	3.6 mm	DS: 3.6 mm SS: 2.0 mm		
FLASH TYPE		MLC durabit™ /	pSLC everbit ™			
DENSITY RANGE durabit everbit	8 GB - 480 GB 16 GB - 240 GB	30 GB - 480 GB 16 GB - 240 GB	30 GB - 240 GB 16 GB - 120 GB	30 GB - 480 GB 16 GB - 240 GB		
DATA RETENTION	10 years @ life begin 1 year @ life end					
ENDURANCE ENTERPRISE WL	durabit: max o.6 TBW / GB drive capacity everbit: max 3.8 TBW / GB drive capacity					

TEMPERATURE

OPERATING TEMPERATURE	Commercial: o°C to +70°C Industrial: -40°C to +85°C
STORAGE TEMPERATURE	-40°C to +85°C

PERFORMANCE

BURST RATE (MB/S)	up to 600	up to 600	up to 600
SEQUENTIAL READ (MB/S)	up to 520 / 520	up to 520 / 520	up to 520 / 520
SEQUENTIAL WRITE (MB/S)	up to 450 / 450	up to 340 / 415	up to 450 / 450
RANDOM 4KB READ (IOPS)	up to 75,000 / 80,000	up to 72,000 / 80,000	up to 75,000 / 80,000
RANDOM 4KB WRITE (IOPS)	up to 75,000 / 75,000	up to 78,000 / 73,000	up to 75,000 / 75,000

ROBUSTNESS

MTBF	≥2,000,000 hours
SHOCK	1,500 G, 0.5 ms
VIBRATION	50 G, 131-2,000 Hz
HUMIDITY	85 % RH 85°C, 1,000 hrs

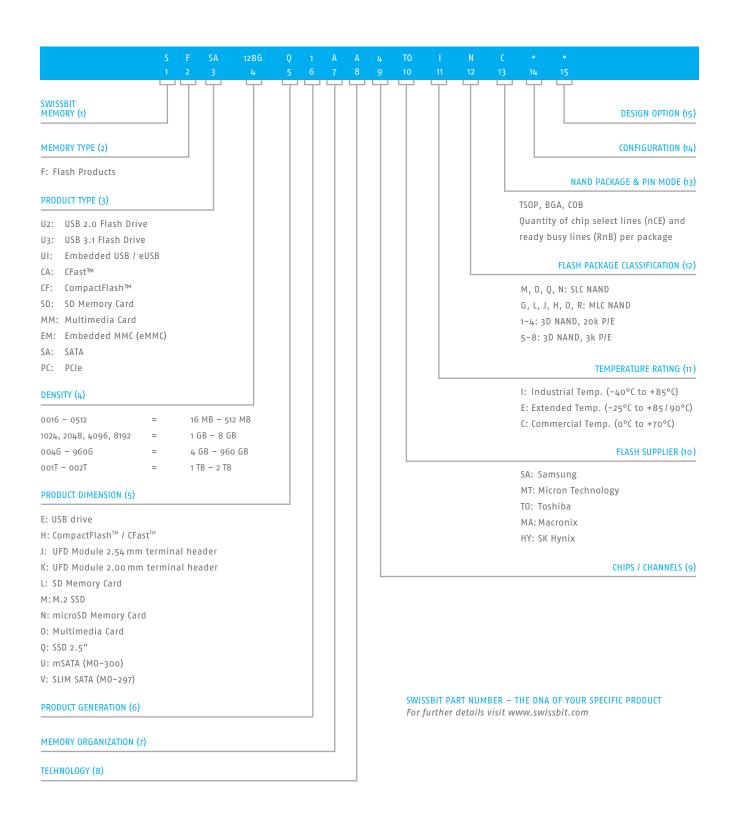
ELECTRICAL DATA

VOLTAGE	3.3 V ± 5 %	5 V ± 10 %	3.3 \	/ ± 5 %
POWER CONSUMPTION	typ 500 mA	typ 450 mA	typ 420 mA	typ 500 mA
	max 960 mA	max 750 mA	max 480 mA	max 960 mA
	Idle 115 mA	Idle 110 mA	Idle 110 mA	Idle 115 mA
	DEVSLP 35 mA	DEVSLP 55 mA	DEVSLP 35 mA	DEVSLP 35 mA

FEATURE LIST

FEATURES & TOOLS		NC Advanced Wear Levelin In-field fir	wer Fail Safety Q, TRIM g & Bad Block management rmware update .R.T. based Life Time Monitoring
PART NUMBER	SFSAxxxxUvAAxss-t-dd- rrr-ccc	SFSAxxxxVvAAxss-t-dd- rrr-ccc	SFSAxxxxMvAAxss-t-dd-rrr-ccc

SWISSBIT PART NUMBER – THE DNA OF YOUR SPECIFIC PRODUCT





	**	4		000		40			44				∞	WAF
F-600	•	•	•	*	•	•	•	*	•	•	•	*	0	•
F-60 / F-66	•	•	•	*	•	•	•	*	•	•	•	*	0	•
F-50 / F-56	•	•	•	*	•	•	•	*	•	•	•	•	0	0
F-240	•	•	•	*	0	•	0	*	•	*	•	0	•	0

★ Industry Leading; • default implemented; • on request; • not available



F-600 F-60 / F-66 F-50 / F-56 F-240



GENERAL INFORMATION

ТҮРЕ		CFast™ CARD								
INTERFACE DATA TRANSFER MODE		CFast™ 2.0 – SATA III – 6 Gbit/s ATA8								
CONNECTOR	CFast™ Type I									
OUTLINE DIMENSIONS		36.4 x 42.8 x 3.6 mm								
FLASH TYPE	SLC	MLC durabit™ / pSLC everbit™	MLC / pSLC	SLC						
DENSITY RANGE	8 GB - 64 GB	MLC: 8 GB - 240 GB pSLC: 16 GB - 120 GB	MLC: 8 GB - 256 GB pSLC: 4 GB - 128 GB	2 GB - 64 GB						
DATA RETENTION		10 years @ life beg	n 1 year @ life end							
ENDURANCE ENTERPRISE WL	8.7 TBW per GB drive capacity	o.6 TBW / 3.8 TBW per GB drive capacity	o.o4 TBW / o.32 TBW per GB drive capacity	100,000 P/E cycles (Flash cell level)						

TEMPERATURE

OPERATING TEMPERATURE	Commercial: o°C to +70°C Industrial: -40°C to +85°C
STORAGE TEMPERATURE	-40°C to +85°C

PERFORMANCE

SEQUENTIAL READ (MB/S) up to 520 up to 520 / 520 up to 500 / 510 up to 120 SEQUENTIAL WRITE (MB/S) up to 245 up to 180 / 415 up to 330 / 415 up to 120 RANDOM 4KB READ (IOPS) up to 76,000 up to 72,000 / 80,000 up to 53,000 / 32,000 up to 3,200 RANDOM 4KB WRITE (IOPS) up to 54,000 up to 43,000 / 75,000 up to 74,000 / 66,000 up to 75	BURST RATE (MB/S)	up to 600	up to 600	up to 600	up to 300
RANDOM 4KB READ (IOPS) up to 76,000 up to 72,000 / 80,000 up to 53,000 / 32,000 up to 3,200	SEQUENTIAL READ (MB/S)	up to 520	up to 520 / 520	up to 500 / 510	up to 120
pulpour (on up) to (one)	SEQUENTIAL WRITE (MB/S)	up to 245	up to 180 / 415	up to 330 / 415	up to 120
RANDOM 4KB WRITE (IOPS) up to 54,000 up to 54,000 up to 75,000 up to 74,000 / 66,000 up to 75	RANDOM 4KB READ (IOPS)	up to 76,000	up to 72,000 / 80,000	up to 53,000 / 32,000	up to 3,200
	RANDOM 4KB WRITE (IOPS)	up to 54,000	up to 43,000 / 75,000	up to 74,000 / 66,000	up to 75

ROBUSTNESS

MTBF	≥ 2,000,000 hours	≥ 2,500,000 hours						
SHOCK	1,500 G, 0.5 ms	1,500 G						
VIBRATION	50 G, 131-2,000 Hz	20 G						
HUMIDITY	85 % RH 85°C, 1,000 hrs							

ELECTRICAL DATA

VOLTAGE		3.3 V ± 5 %								
POWER CONSUMPTION	typ 450 mA	typ 400 mA	typ 290 mA	typ 500 mA						
	max 715 mA	max 495 mA	max 420 mA	max 960 mA						
	Idle 105 mA	Idle 110 mA	Idle 75 mA	Idle 115 mA						
	DEVSLP 35 mA	DEVSLP 35 mA	DEVSLP 35 mA	PHYSLP <25 mA						

	max 715 mA Idle 105 mA DEVSLP 35 mA	max 495 mA Idle 110 mA DEVSLP 35 mA	max 420 mA Idle 75 mA DEVSLP 35 mA	max 960 mA Idle 115 mA PHYSLP <25 mA		
FEATURE LIST						
FEATURES & TOOLS		Proven Power Fail Saf NCQ, TRIM Advanced Wear Leveling & Bad Blo In–field firmware upd M Tool & SDK for S.M.A.R.T. based	ck management late	Proven Power Fail Safety Sophisticated Wear Leveling & Bad Block management Read Disturb Management TRIM Low Power Consumption Security & SBZoneProtection features available SBLTM Tool & SDK for S.M.A.R.T. based Life Time Monitoring		
PART NUMBER	SFCAxxxxHvAAxss-t-dd-rrr-ccc SFCAxxxxHvE					

CompactFlash™

To this day, CompactFlash™ (CF) cards are widely used as boot and data logging devices in many NetCom and industrial applications.

Swissbit's dedication to these markets is shown by the broad portfolio and continuing support of various CF cards.
Swissbit products are developed with a strong focus on quality, reliability, robustness, and longevity.

Swissbit's CF Series C-3xo and C-4xo are offered in both commercial (0°C to +70°C) and industrial (-40°C to +85°C) temperature ranges. The most recent CF card product family is the C-300 Longevity series, which offers maximum long-term availability (until at least 2021). The impressive feature list and proven high quality has convinced many customers to rely on Swissbit solutions for their CompactFlash™ based applications.



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C-300	•	•	•	•	0	•	*	•	0	0	•
C-300 LONGEVITY	•	•	•	*	0	•	*	•	•	0	*
C-320	•	•	•	•	•	•	*	•	•	0	•
C-440	•	•	•	*	•	•	*	•	*	*	•

★ Industry Leading; • default implemented; • on request; • not available

C-300 C-300L C-320 C-440









GENERAL INFORMATION

ТҮРЕ		COMPACTFLASH™ CARD									
INTERFACE DATA TRANSFER MODE	True I	CFA5.0 True IDE / PC card UDMA6, MDMA4 &									
CONNECTOR		CFC Type I									
OUTLINE DIMENSIONS	36.4 x 42.8 x 3.3 mm										
FLASH TYPE		SLC									
DENSITY RANGE	128 MB - 8 GB	32 MB - 8 GB	2 GB - 32 GB	2 GB - 64 GB							
DATA RETENTION		10 years @	life begin 1 year @ life end								
ENDURANCE			100,000 P/E Cycles (Flash Cell Level)								

TEMPERATURE

OPERATING TEMPERATURE	Commercial: o°C to +70°C Industrial: -40°C to +85°C
STORAGE TEMPERATURE	-50°C to +100°C

PERFORMANCE

BURST RATE (MB/S)	up to 66	up to 66	up to 66	up to 133
SEQUENTIAL READ (MB/S)	up to 37	up to 37	up to 45	up to 65
SEQUENTIAL WRITE (MB/S)	up to 20	up to 20	up to 35	up to 40
RANDOM 4KB READ (IOPS)	up to 3,300	up to 3,300	up to 2,800	up to 2,400
RANDOM 4KB WRITE (IOPS)	up to 40	up to 50	up to 44	up to 300 (with TRIM)

ROBUSTNESS

МТВБ	≥ 3,000,000 hours		
SHOCK	1,500 G		
VIBRATION	20 G		
HUMIDITY	85 % RH 85°C, 1,000 hrs		

ELECTRICAL DATA

VOLTAGE	3.3 V \pm 5 % 5 V \pm 10 %			
POWER CONSUMPTION	PIO typ 50 mA @ 3.3 V	PIO typ 60 mA @ 3.3 V	PIO typ 60 mA @ 3.3 V	
	DMA typ 70 mA @ 3.3 V	DMA typ 90 mA @ 3.3 V	DMA typ 80 mA @ 3.3 V	
	DMA typ 110 mA @ 5 V	DMA typ 130 mA @ 5 V	DMA typ 90 mA @ 5 V	

FEATURE LIST

FEATURES & TOOLS	Sophisticated Wear Leveli Security & SBZoneProt	wer Fail Safety ng & Bad Block management tection features available R.T. based Life Time Monitoring	Sophisticated Bad Block r Read Disturb Ti Security & SB features SBLTM Tool & S	ver Fail Safety Wear Leveling & management Management RIM ZoneProtection available DK for S.M.A.R.T. me Monitoring
PART NUMBER	SFCFxxxxHxBKxss-t-xx-	SFCFxxxxHxBKxss-t-xx-	SFCFxxxxHxB0xss-t-dd-	SFCFxxxxHvBUxss-t-dd-
	rrr-ccc	rrr-ccc	rrr-ccc	rrr-ccc

SD Memory Cards

Secure Digital (SD) memory cards have a widespread use in industrial and automotive applications, ranging from read only applications as in navigation systems to utilization as boot media, for video recording or data logging.

Swissbit's Industrial Secure Digital (SD) card series are designed for high sustained performance and endurance and are manufactured and tested in Swissbit's own fab to withstand extreme

environmental conditions.

The SLC based S-450 offers best sequential performance and highest endurance, while the durabit™ S-45 and the everbit™ S-46 series rely on MLC NAND. They combine an industry leading controller with sub-page based firmware and achieve unprecedented random write performance. A long list of hardware and firmware features make these cards the best available choice.



S-200 / 220 S-450**GENERAL INFORMATION** SD MEMORY CARD SD MEMORY CARD SD MEMORY CARD (SD / SDHC) TYPE (SDHC / SDXC) (SD / SDHC / SDXC) INTERFACE SD 2.0, Class 6 / 10 SD 3.0, Class 10, UHS-I DATA TRANSFER MODE CONNECTOR **OUTLINE DIMENSIONS** 32 X 24 X 2.1 mm **FLASH TYPE** SLC MLC durabit™ pSLC everbit™ 2 GB (SD) 512 MB - 2 GB (SD) 512 MB - 2 GB (SD) 4 GB - 32 GB (SDHC) **DENSITY RANGE** 4 GB - 32 GB (SDHC) 4 GB - 8 GB (SDHC) 4 GB - 32 GB (SDHC) 64 GB - 128 GB (SDXC) 64 GB (SDXC) 10 years @ life begin | 1 year @ life end **DATA RETENTION** 100,000 P/E Cycles 3,000 P/E Cycles 20,000 P/E Cycles **ENDURANCE** (Flash Cell Level) (Flash Cell Level) (Flash Cell Level) **TEMPERATURE** Extended: -25°C to +85°C OPERATING TEMPERATURE Industrial: -40°C to +85°C STORAGE TEMPERATURE -40°C to +100°C **PERFORMANCE** up to 104 **BURST RATE (MB/S)** up to 25 up to 104 up to 104 SEQUENTIAL READ (MB/S) up to 90 up to 24 up to 40 up to 50 SEQUENTIAL WRITE (MB/S) up to 19 up to 12 up to 55 up to 75 RANDOM 4KB READ (IOPS) up to 1,400 up to 750 up to 1,350 up to 1,200 **RANDOM 4KB WRITE (IOPS)** up to 90 up to 650 up to 1,400 up to 30 **ROBUSTNESS MTBF** ≥ 3,000,000 hours SHOCK 1,500 G 1,000 G **VIBRATION** 15 G HUMIDITY 85 % RH 85°C, 1,000 hrs **ELECTRICAL DATA VOLTAGE** 2.7 -3.6 V Normal POWER CONSUMPTION Read typ 40 mA Read typ 75 mA Write typ 65 mA Write typ 75 mA **FEATURE LIST** Proven Power Fail Safety Sophisticated Wear Leveling Proven Power Fail Safety & Bad Block management Sophisticated Wear Leveling & Bad Block management **FEATURES & TOOLS** Autonomous Data Care Management Diagnostic features & Life

Time Monitoring through SD / SPI command set

SFSDxxxxLvBNxss-t-dd-

PART NUMBER

SBLTM Tool & SDK for detailed Life Time Monitoring

SFSDxxxxLxBMxss-t-dd-rrr-ccc

microSD Cards

Manufactured in Swissbit's own fab with chip on board technology and based on a dedicated industrial controller and reliable NAND flash, the microSD memory cards withstand extreme environmental conditions and provide the highest level of mechanical stability and enhanced ESD protection. Furthermore, the hard gold SD connectors endure a minimum of 20,000 insertion cycles.

The different series in SLC technology (S-300u, S-200u and S-450u) as well as the MLC products S-45u and the pSLC configuration S-46u feature a long list of hardware and firmware improvements. Sub-page based firmware, known under the durabit™ and everbit™ brands, enables unprecedented endurance and random write performance for MLC based products. The Swissbit Life Time Monitor support allows you to choose the perfect product for your use case.



S-300u S-200u S-450u S-45u S-46u



SFSDxxxxNxBNxss-t-

ddrrr-ccc

SFSDxxxxNxBWxss-

t-ddrrr-ccc

PART NUMBER

SFSDxxxxNxBMxss-t-dd-rrr-ccc

Managed NAND

Small form factor embedded systems have often used NAND components which were directly interfaced and managed by the host controller software. With increasing complexity of NAND devices and their management this task has become a challenge.

Managed NAND is the solution: a single small size BGA component incorporates multiple Flash dies, a NAND controller and the management firmware and eases the integration. Swissbit's e.MMC EM-20 family covers multiple densities and interface speeds. It fulfills the JEDEC 5.0 standard and offers a reliable and stable storage product with true industrial operating temperature. Sophisticated NAND management makes the EM-20 ideal for applications like POS/POI, PLC, IoT, gaming, medical, or as a general boot medium for embedded applications.



EM-20 / EM-26



GENERAL INFORMATION

ТҮРЕ	E.MMC						
STANDARD & INTERFACE	JEDEC e.MMC 5.0 Standard (JESD84-B50), 1-bit, 4-bit, 8-bit up to HS400						
PACKAGE	53-ball BGA, o.5mm pitch						
OUTLINE DIMENSIONS	11.5 x 13 x 1 mm						
FLASH TYPE	MLC / pSLC reliable mode						
DENSITY RANGE	4 GB - 64 GB MLC / 2 GB - 32 GB pSLC						
DATA RETENTION	10 years @ life begin 1 year @ life end						
ENDURANCE	3,000 P/E cycles MLC mode / 20,000 P/E cycles reliable mode (Flash Cell Level)						

TEMPERATURE

OPERATING TEMPERATURE	Industrial: -40°C to +85°C
STORAGE TEMPERATURE	-40°C to +85°C

PERFORMANCE

BURST RATE	up to 400
SEQUENTIAL READ (MB/S)	up to 270
SEQUENTIAL WRITE (MB/S)	up to 160
RANDOM 4KB READ (IOPS)	up to 5,900
RANDOM 4KB WRITE (IOPS)	up to 2,100

ELECTRICAL DATA

VOLTAGE	VCCQ: 1.70-1.95V / 2.70-3.60V ; VCC: 2.70-3.60						
POWER CONSUMPTION	Typ. Read Current: 180 mA @ 1.8V VCCQ, 38mA @ 3.3V VCC Typ. Write Current: 105 mA @ 1.8V VCCQ, 80mA @ 3.3V VCC Standby: 20 mA						

FEATURE LIST

FEATURES & TOOLS	High performance up to HS400 mode Sophisticated Wear Leveling & Read Disturb Management Page based FTL Management Production State Awareness Proven Power Fail Safety Security features – secure erase & RPMB
PART NUMBER	SFEMxxxGB1EAxss-I-dd-rrr-ccc



U-50

U-45

U-50k







GENERAL INFORMATION

ТҮРЕ	eUSB FLASH MODULE	eUSB FLASH MODULE	USB FLASH DRIVE				
INTERFACE DATA TRANSFER MODE	USB 3.1 Super Speed / High / Full	USB 2.0 High / FullSpeed	USB 3.1 Super Speed / High / Full				
CONNECTOR	Standard: 2.54 mr Low Profile: 2.00 m	USB 3.0 Type A-Plug					
OUTLINE DIMENSIONS	Standard: 36.8 mm x 26.65 mm x 9.7mm Low Profile: 36.8 mm x 26.65 mm x 6.0mm 68.0 mm x 18.0 mm x 8.2 mm						
FLASH TYPE	SLC / pSLC everbit™ / MLC durabit™						
DENSITY RANGE	SLC: 4 GB - 32 GB pSLC: 4 GB - 32 GB MLC: 8 GB - 64 GB	SLC: 2 GB - 32 GB pSLC: 8 GB - 64 GB MLC: 16 GB - 128 GB					
DATA RETENTION	10 years @ life begin 1 year @ life end						
ENDURANCE	100k / 20k / 3k P/E Cycles (Flash Cell Level)						

TEMPERATURE

OPERATING TEMPERATURE	Commercial: o°C to +70°C Industrial: -40°C to +85°C
STORAGE TEMPERATURE	-40°C to +100°C

PERFORMANCE

BURST RATE (MB/S)	up to 625	up to 60	up to 625
SEQUENTIAL READ (MB/S)	up to 175 / 170 / 140	up to 36 / 39 / 23	up to 175 / 170 / 140
SEQUENTIAL WRITE (MB/S)	up to 95 / 90 / 60	up to 27 / 29 / 18	up to 95 / 90 / 60
RANDOM 4KB READ (IOPS)	up to 3,050 / 3,200 / 2,500	up to 1,600 / 1,800 / 1,400	up to 3,050 / 3,200 / 2,500
RANDOM 4KB WRITE (IOPS)	up to 1,000 / 1,050 / 700	up to 30 / 800 / 550	up to 1,000 / 1,050 / 700
DODUGENESS			

ROBUSTNESS

MTBF	≥3,000,000 hours						
SHOCK	1,500 G	1,500 G					
VIBRATION	50 G	20 G					
HUMIDITY	85% RH 85°C, 500 hrs						

ELECTRICAL DATA

VOLTAGE	3.3 V ±5 % / 5 V ±10 %	5 V ± 10 %
POWER CONSUMPTION	Full Speed typ 70 mA High Speed typ 80 mA	

FEATURE LIST						
FEATURES & TOOLS	Proven Power Fail Safety Windows / Linux — Spare block read out Bootable USB Drive Supports latest OS as Fixed Drive Connector pitch & key variations available Shock & vibration resistant					
	Support a Connector pitch and	Hot pluggable removable drive				
PART NUMBER	2.54 mm: SFUIxxxxJxAExss-t-dd-rrr-ccc 2.00 mm: SFUIxxxxKxAExss-t-dd-rrr-ccc	2.54 mm: SFUIXXXXJvABxss-t-dd-rrr-ccc 2.00 mm: SFUIXXXXKvABxss-t-dd-rrr-ccc	SFU3xxxxEvAExss-t-dd-rrr-ccc			



SECURITY SOLUTIONS

Security is becoming mandatory in diverse markets. Data breaches and compromised IT environments are becoming a reality.

Legal requirements force solution providers to use state-of-the-art security concepts. In Germany DSGVO or pan-European GDPR are legally binding data protection laws that need to be fulfilled. If critical systems fail or sensitive data leak, severe fines and penalties are imminent. Recent security alerts like Spectre, Meltdown and other severe problems like vulnerability of the ubiquitous Intel Management Engine clearly demonstrate that security cannot just be placed somewhere in an appendix of a product specification but needs to be part of the DNA of each product. While PC systems are easily maintained by online-distributed SW packages, industrial and automotive systems still suffer low maintenance cycles and therefore stay vulnerable over a longer period. The Industrial IoT has highest requirements on quality and security. Always-on devices taking over more and more responsibility in our everyday life offer huge attack surfaces that need highest security and at the same time ease of maintenance over the complete life cycle. Flexible and intuitive secure update concepts as well-trusted boot security are efficiently implemented based on the combination of security and storage by Swissbit products.

SWISSBIT OFFERS PRODUCT RELATED SERVICES:

- SECURITY FIRMWARE AND DRIVERS
- LOGO PRINTING
- OPTICAL AND ELECTRONIC PERSONALIZATION
- DESIGN-IN OF CONSIGNED SMART CARD CHIPS

AS WELL AS EXTENDED SERVICES:

- SECURITY CONSULTING
- SECURITY TRAINING
- CUSTOMER SUPPORT
- DESIGN-IN SUPPORT
- CONNECTION WITH ECO-SYSTEM PARTNER NETWORK FOR TURN KEY SOLUTIONS AND QUICK TIME TO MARKET



			X	KK H	\$	L	c	6		
SE	•	•	•	•	•	0	0	0	0	0
VE	•	•	•	•	•	•	•	0	0	0
FE	•	•	•	•	•	•	•	0	0	0
PE	•	•	•	•	•	•	•	•	•	•
DP	0	0	0	0	0	0	0	•	•	•
WE	0	•	0	0	0	0	0	0	•	•

★ Industry Leading; • default implemented; • on request; • not available

SECURITY EDITIONS



STANDARD EDITION SE

The Standard Edition SE fits best into authentication and PKI (Public Key Infrastructure) use cases. The card is supported by leading middleware vendors in mobile, desktop, and tablet use cases to ensure a seamless design—in into existing security infrastructures.



VOICE EDITION VE

The Voice Edition VE provides Elliptic Curve Cryptography. The enormous advantage of computation and security combined with small certificate sizes makes a VE card ideal for online key and certificate exchange.



PREMIUM EDITION PE

The Premium Edition PE combines high end smartcard security with state of the art data protection like CD-ROM, WORM, hidden storage. Data can be protected and digitally signed and fully AES encrypted in one device.



DATA PROTECTION DP

The Data Protection DP cards offer state of the art data protection. All data stored in the card is AES encrypted in high speed and can be protected by various options like CD-ROM, PIN protected data, hidden storage, WORM data area.



FE CARDS

FE cards provide a secure element according FIPS 140-2 certification. US governmental organizations and enterprises that need to follow the FIPS 140-2 security standard.



WORM CARDS

WORM cards can be written once and read multiple times. Typical use cases for WORM are secure transaction logging as in cash registers or audit trails. All records are hash chained and can be digitally signed to prove origin. Once written, the individual records cannot be modified or deleted. The storage can be fully accessed with the administrator key provided to the respective authorities.

SE / VE / PE FE

527 (27)	- 		
Infineon SLE 78 smart card chip CC EAL 5+ HW and OS	Infineon SLE 78 smart card chip FIPS 140–2 level 3		
Java card 3.0.4 Global Platform 2.2.1	Java card V2.2.x (ext. of V3.0) Global Platform 2.2.1 Gemalto ID Core 30		
RSA up to 2048 bit optional ECC up to 512 / 521 bit AES up to 256 bit SHA2 up to 512 bit RNG AIS31, FIPS-140	RSA up to 2048 bit ECC up to 512 / 521 bit AES up to 256 bit SHA2 up to 512 bit		
Compatible Middleware: • AET SafeSign • Charismathics • Cryptovision	Compatible Middleware: • Gemalto		
80 k EEPROM secure storage	160 k EEPROM secure storage		
Windows, Mac, Linux, Android SDK available PKCS#11 Middleware	Windows, Mac, Linux, BlackBerry, Android SDK available		
	Infineon SLE 78 smart card chip CC EAL 5+ HW and OS Java card 3.0.4 Global Platform 2.2.1 RSA up to 2048 bit optional ECC up to 512 / 521 bit AES up to 256 bit SHA2 up to 512 bit RNG AIS31, FIPS-140 Compatible Middleware:		

		P2-1000	P5-45	P5-45u	P5-46	P5-46U	P5-450	P5-450u
COMPLIANCE	MPLIANCE SD 3.0 SD, ASSD V1.1							
DATA TRANSFE	ER	SPI mode supported Speed class 10	UHS-1 Speed class 10					
TEMPERATURE			-25°C to 85°C					
COMPATIBLE TO		S-100u	S-45	S-45u	S-46	S-46u	S-450	S-450u
FLASH TYPE		MLC	MLC pSLC		SLC			
DENSITY	SE / VE / FE / PE	8 GB - 16 GB	8 GB - 16 GB	8 GB - 16 GB	4 GB - 8 GB	4 GB - 8 GB	4 GB - 32 GB	512 MB - 2 GB
	DP	8 GB – 32 GB	4 GB - 64 GB	4 GB - 32 GB	4 GB - 32 GB	4 GB - 16 GB	4 GB - 32 GB	512 MB - 8 GB

SECURITY PRODUCT MATRIX		SE Standard Edition	VE Voice Edition	FE FIPS Edition	PE Premium Edition	DP Data Protection
MOBILE / PC	PS-100u microSD	8 GB – 16 GB	8 GB – 16 GB	8 GB - 16 GB		8 GB – 32 GB
MEDICAL AUTOMOTIVE IOT	PS-45 SD	8 GB – 16 GB	8 GB - 16 GB	8 GB - 16 GB	8 GB - 16 GB	8 GB - 64 GB
	PS-45u microSD	8 GB – 16 GB	8 GB - 16 GB	8 GB - 16 GB	8 GB - 16 GB	8 GB - 32 GB
	PS-46 SD	4 GB - 8 GB	4 GB - 8 GB	4 GB - 8 GB	4 GB - 8 GB	4 GB - 32 GB
	PS-46u microSD	4 GB - 8 GB	4 GB - 8 GB	4 GB - 8 GB	4 GB - 8 GB	4 GB - 16 GB
INDUSTRIAL	PS-450 SD	4 GB - 32 GB	4 GB - 32 GB	4 GB - 32 GB	4 GB - 32 GB	4 GB - 32 GB
	PS-450u microSD	0.5 GB - 2 GB	0.5 GB - 2 GB	0.5 GB - 2 GB	0.5 GB - 2 GB	0.5 GB - 2 GB



with 25 years of experience, Swissbit successfully uses advanced packaging technologies to achieve the smallest form factors and to build multi-chip-packages. With this electronic integration approach, our products provide more functionality inside one package, various functional blocks (RF, digital, sensors, security, and memory) as well as passive components are combined. Having all necessary capabilities inhouse we have the best design for reliability, test and production.

For our memory products we developed processes for stacking multiple large dies and wire bonding the smallest bond pads. Swissbit's technology portfolio combined with its strong engineering knowhow and experience enables new,

innovative MCP (Multi Chip Packages) / SiP / COB configurations like stacked dies, side-by-side, sensors integration, and much more.

Our customers benefit from reduced development cost and higher yields and reliability. We use advanced packaging technology which allows production of small volume series (up to 50,000 pieces/month) with short lead-times and in-time delivery.

Swissbit produces and develops according to ISO 9001:2015, IATF 16949, ISO 5001:2011 and ISO 14001:2015 approved processes and is an experienced partner in global industrial and automotive accounts.





SUBSTRATE / PCB

- Fine etch
- Low overall thickness



DIE BONDING

- Multi & single chip
- Thin die (> 50um)
- Large die 15 x 15 mm



TRANSFER MOLDING

- · Large area map
- Top-foil
- · MicroSD, BGA, LGA



SMT

- 01005 passives
- Cleaning



WIRE BONDING

- Au, Ag-alloy, AL wire
- 17.5 32 um wire
- Chain bonding



SINGULATION

- Sawing
- Laser cutting



DIE ATTACH

- DAF tape
- Stencil print
- Dispensing



ENCAPSULATION

- Dam & Fill
- Underfill
- Glob top



MARKING

- Laser marking
- Tampon print
- Labelling



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